## Onsemi

### **Surface Mount Schottky Power Rectifier**

## MBRAF3200, NRVBAF3200

This device employs the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity protection diodes in surface mount applications where compact size and weight are critical to the system.

#### Features

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- Highly Stable Oxide Passivated Junction
- Very High Blocking Voltage 200 V
- 150°C Operating Junction Temperature
- Guard-Ring for Stress Protection
- NRVB Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- This is a Pb-Free Device

#### **Mechanical Charactersistics**

- Case: Epoxy, Molded, Epoxy Meets UL 94, V-0
- Weight: 95 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Cathode Polarity Band
- Device Meets MSL 1 Requirements
- ESD Ratings: Machine Model = A
  - Human Body Model = 1B

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	200	V
Average Rectified Forward Current $(T_L = 100^{\circ}C)$	I <sub>F(AV)</sub>	3.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	100	A
Operating Junction Temperature	ТJ	-65 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### SCHOTTKY BARRIER RECTIFIER 3.0 AMPERE **200 VOLTS**



SMA-FL CASE 403AA STYLE 6

#### MARKING DIAGRAM



= Year

Α

Y

WW = Work Week

= Pb-Free Package

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MBRAF3200T3G	SMA-FL (Pb-Free)	5000 / Tape & Reel
NRVBAF3200T3G	SMA-FL (Pb-Free)	5000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction-to-Lead (Note 1)	$R_{\theta JL}$	25	°C/W
Thermal Resistance, Junction-to-Ambient (Note 1)	$R_{\theta JA}$	90	°C/W
Thermal Characteristic, Junction-to-Case Top (Note 2)	$\Psi_{JCT}$	34	°C/W

1. 1 inch square pad size ( $1 \times 0.5$  inch) for each lead on FR4 board.

2. PCB Cu area = 600 mm<sup>2</sup>, single layer with 1 oz thickness.

#### **ELECTRICAL CHARACTERISTICS**

Characteristic	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (Note 3) ( $I_F = 3.0 \text{ A}, T_J = 25^{\circ}\text{C}$ ) ( $I_F = 4.0 \text{ A}, T_J = 25^{\circ}\text{C}$ ) ( $I_F = 3.0 \text{ A}, T_J = 150^{\circ}\text{C}$ )	V <sub>F</sub>	0.84 0.86 0.62	V
Maximum Instantaneous Reverse Current (Note 3) (Rated dc Voltage, $T_J = 25^{\circ}C$ ) (Rated dc Voltage, $T_J = 150^{\circ}C$ )	I <sub>R</sub>	1.0 6.0	mA mA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.









Figure 2. Maximum Forward Voltage



Figure 3. Typical Reverse Current

Figure 4. Maximum Reverse Current

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Figure 7. Typical Transient Thermal Response, Junction-to-Ambient

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